TOSHIBA Field Effect Transistor Silicon N Channel MOS Type (π-MOSVI)

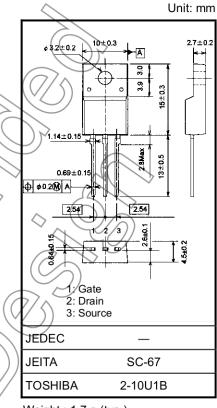
2SK3563

Switching Regulator Applications

- Low drain-source ON resistance: R_{DS} (ON) = 1.35 Ω (typ.)
- High forward transfer admittance: |Y_{fs}| = 3.5 S (typ.)
- Low leakage current: $I_{DSS} = 100 \mu A (max) (V_{DS} = 500 V)$
- Enhancement mode: V_{th} = 2.0 to 4.0 V (V_{DS} = 10 V, I_D = 1 mA)

Absolute Maximum Ratings (Ta = 25°C)

Characteristics		Symbol	Rating	Unit
Drain-source voltage		V_{DSS}	500	$\langle \lambda \rangle \langle \lambda \rangle$
Drain-gate voltage ($R_{GS} = 20 \text{ k}\Omega$)		V_{DGR}	500	(
Gate-source voltage		V _{GSS}	±30	/<
Drain current	DC (Note 1)	I _D	5	
	Pulse (t = 1 ms) (Note 1)	I _{DP}	20	∨ A
Drain power dissipation (Tc = 25°C)		P _D	35	W
Single pulse avalanche energy (Note 2)		EAS	180	(mJ
Avalanche current		IAR	5	A
Repetitive avalanche energy (Note 3)		EAR	3.5	mJ
Channel temperature		((T _{ch}	150	//°c
Storage temperature range		T _{stg}	-55~150	J.C



Weight: 1.7 g (typ.)

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings. Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/Derating Concept and Methods) and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Thermal Characteristics

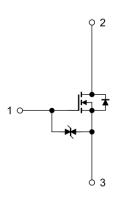
Characteristics	Symbol	Max	Unit
Thermal resistance, channel to case	Rth (ch-c)	3.57	°C/W
Thermal resistance, channel to ambient	Rth (ch-a)	62.5	°C/W

Note 1: Ensure that the channel temperature does not exceed 150°C.

Note 2: $V_{DD}=90~V,~T_{ch}=25^{\circ}C(initial),~L=12.2~mH,~I_{AR}=5~A,~R_{G}=25~\Omega$

Note 3: Repetitive rating: pulse width limited by maximum channel temperature

This transistor is an electrostatic-sensitive device. Please handle with caution.

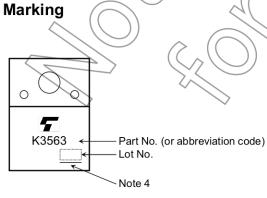


Electrical Characteristics (Ta = 25°C)

Char	acteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage cu	rrent	I _{GSS}	V _{GS} = ±25 V, V _{DS} = 0 V	_	_	±10	μА
Gate-source brea	akdown voltage	V (BR) GSS	$I_G = \pm 10 \ \mu A, \ V_{DS} = 0 \ V$	±30	_	_	V
Drain cut-off curr	ent	I _{DSS}	V _{DS} = 500 V, V _{GS} = 0 V	/_	_	100	μА
Drain-source bre	akdown voltage	V (BR) DSS	$I_D = 10 \text{ mA}, V_{GS} = 0 \text{ V}$	500	_	_	V
Gate threshold v	oltage	V _{th}	$V_{DS} = 10 \text{ V}, I_D = 1 \text{ mA}$	2.0) }_	4.0	V
Drain-source ON	resistance	R _{DS} (ON)	V _{GS} = 10 V, I _D = 2.5 A	\nearrow	1.35	1.50	Ω
Forward transfer	admittance	Y _{fs}	V _{DS} = 10 V, I _D = 2.5 A).5	3.5	_	S
Input capacitance	е	C _{iss}		_	550	_	
Reverse transfer capacitance		C _{rss}	$V_{DS} = 25 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$	_	7	_	pF
Output capacitance		Coss		_	70	_	
Switching time	Rise time	t _r	V _{GS} 0 V		210		
	Turn-on time	t _{on}	0 V		20) —	
	Fall time	t _f	V _{DD} ≃ 225 V	71(10		ns
	Turn-off time	t _{off}	Duty $\leq 1\%$, $t_W = 10 \ \mu s$		50		
Total gate charge	Э	Qg) —	16	_	
Gate-source cha	rge	Q _{gs}	$V_{DD} \simeq 400 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 5 \text{ A}$	_	10	_	nC
Gate-drain charge Qgd		Qgd			6		

Source-Drain Ratings and Characteristics (Ta = 25°C)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Continuous drain reverse current (Note 1))) I _{DR}		_	_	5	Α
Pulse drain reverse current (Note 1)	I _{DRR}		_	_	20	Α
Forward voltage (diode)	V _{DSF}	I _{DR} = 5 A, V _{GS} = 0 V	_	_	-1.7	V
Reverse recovery time	tr	$I_{DR} = 5 \text{ A}, V_{GS} = 0 \text{ V},$	_	1400	_	ns
Reverse recovery charge	Q _{rr}	dl _{DR} /dt = 100 A/μs	_	9	_	μС

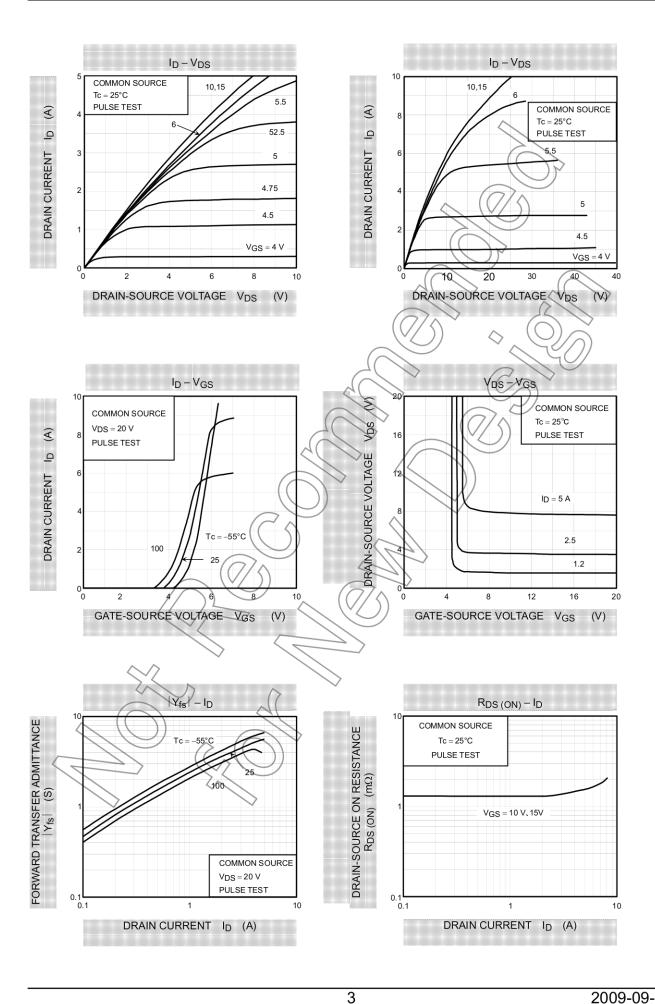


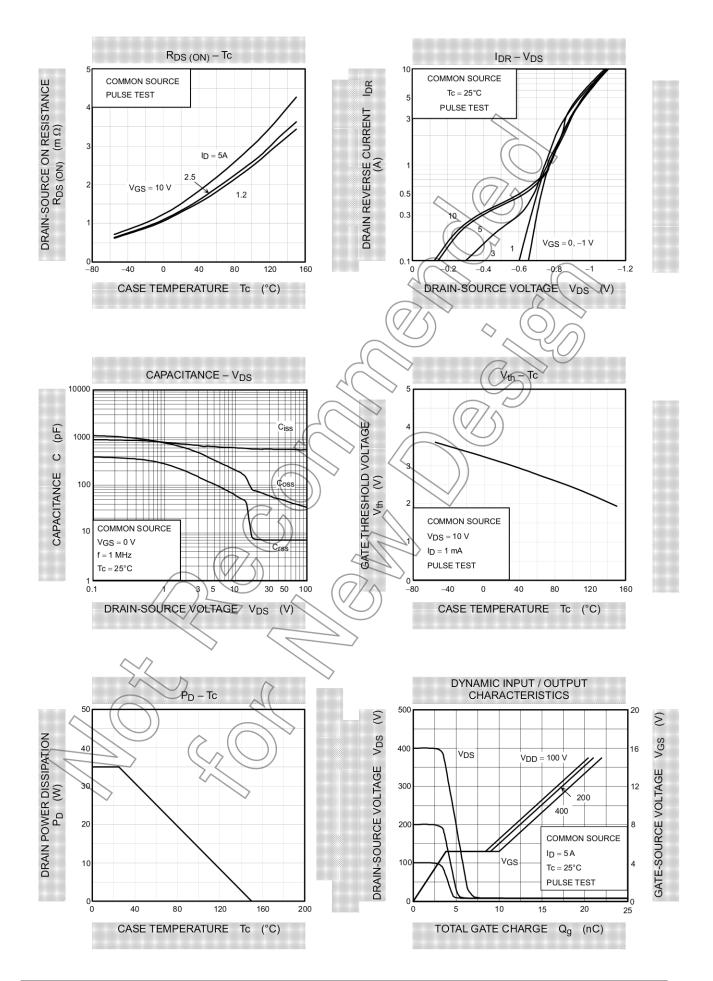
Note 4: A line under a Lot No. identifies the indication of product Labels.

Not underlined: [[Pb]]/INCLUDES > MCV

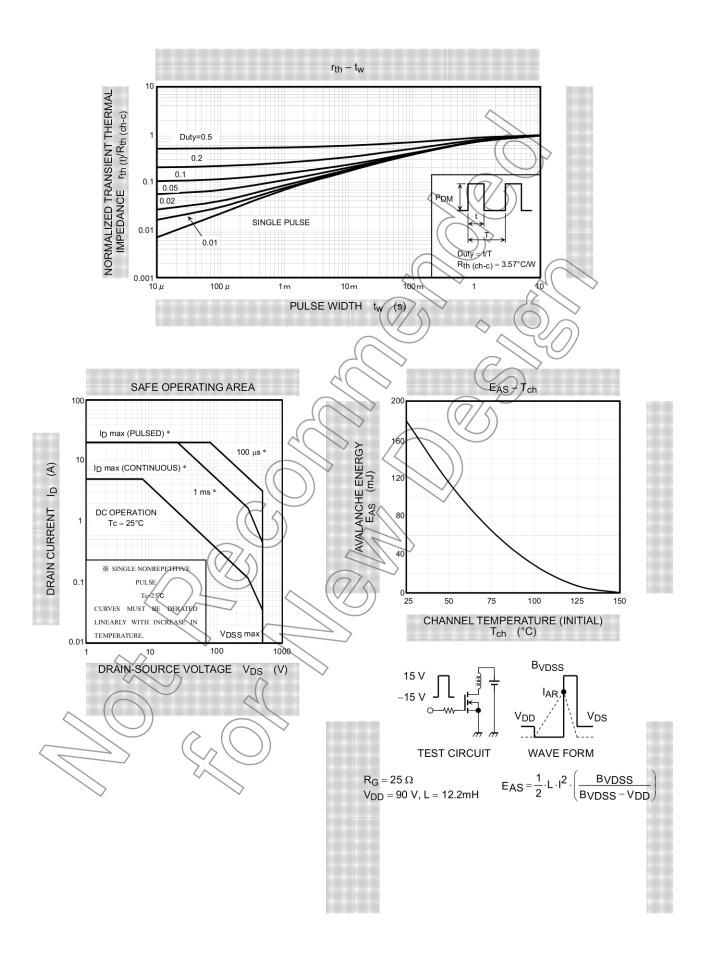
Underlined: [[G]]/RoHS COMPATIBLE or [[G]]/RoHS [[Pb]]

Please contact your TOSHIBA sales representative for details as to environmental matters such as the RoHS compatibility of Product. The RoHS is the Directive 2002/95/EC of the European Parliament and of the Council of 27 January 2003 on the restriction of the use of certain hazardous substances in electrical and electronic equipment.





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